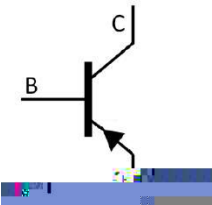


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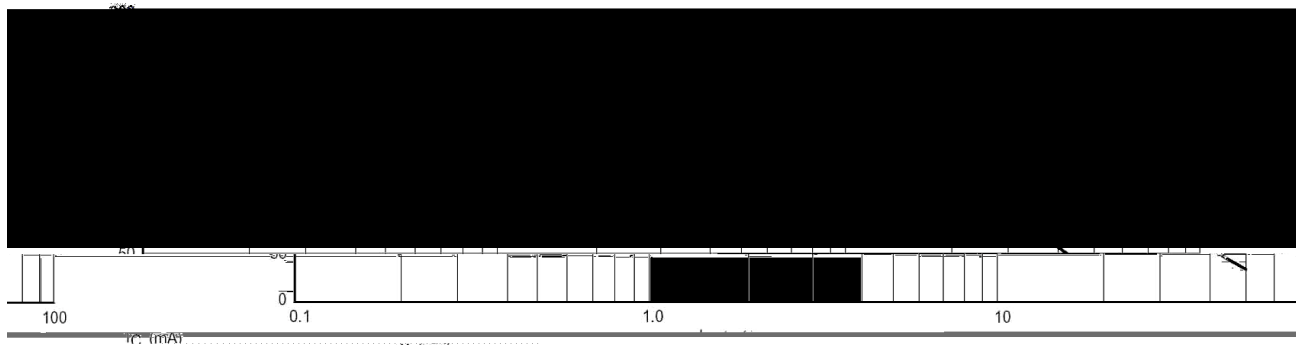


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/ Electrical Characteristic Curve

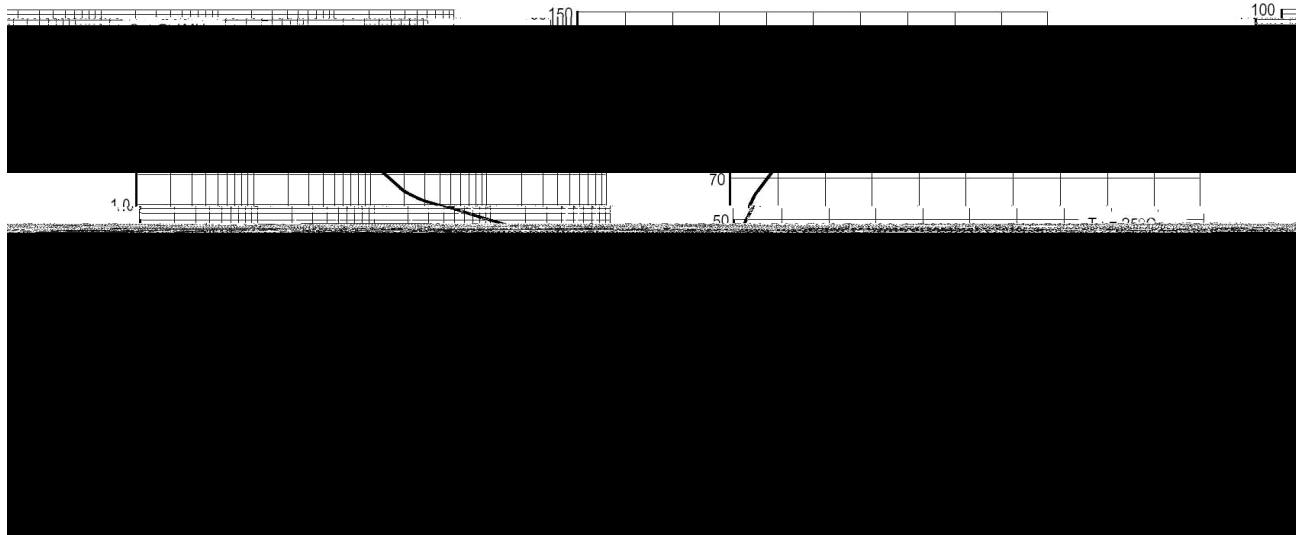
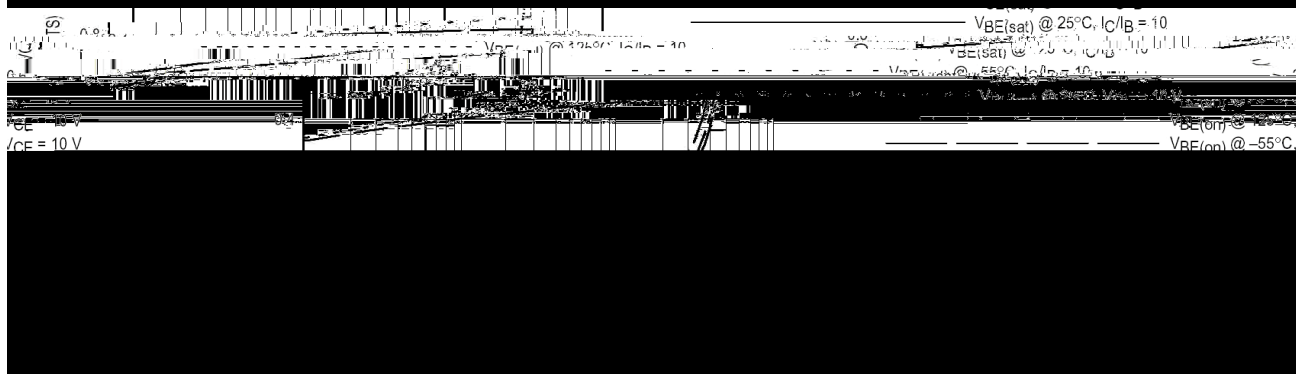
$h_{FE} - I_C$



$C_{ob} - V_{CB}$

$C_{ib} - V_{CB}$

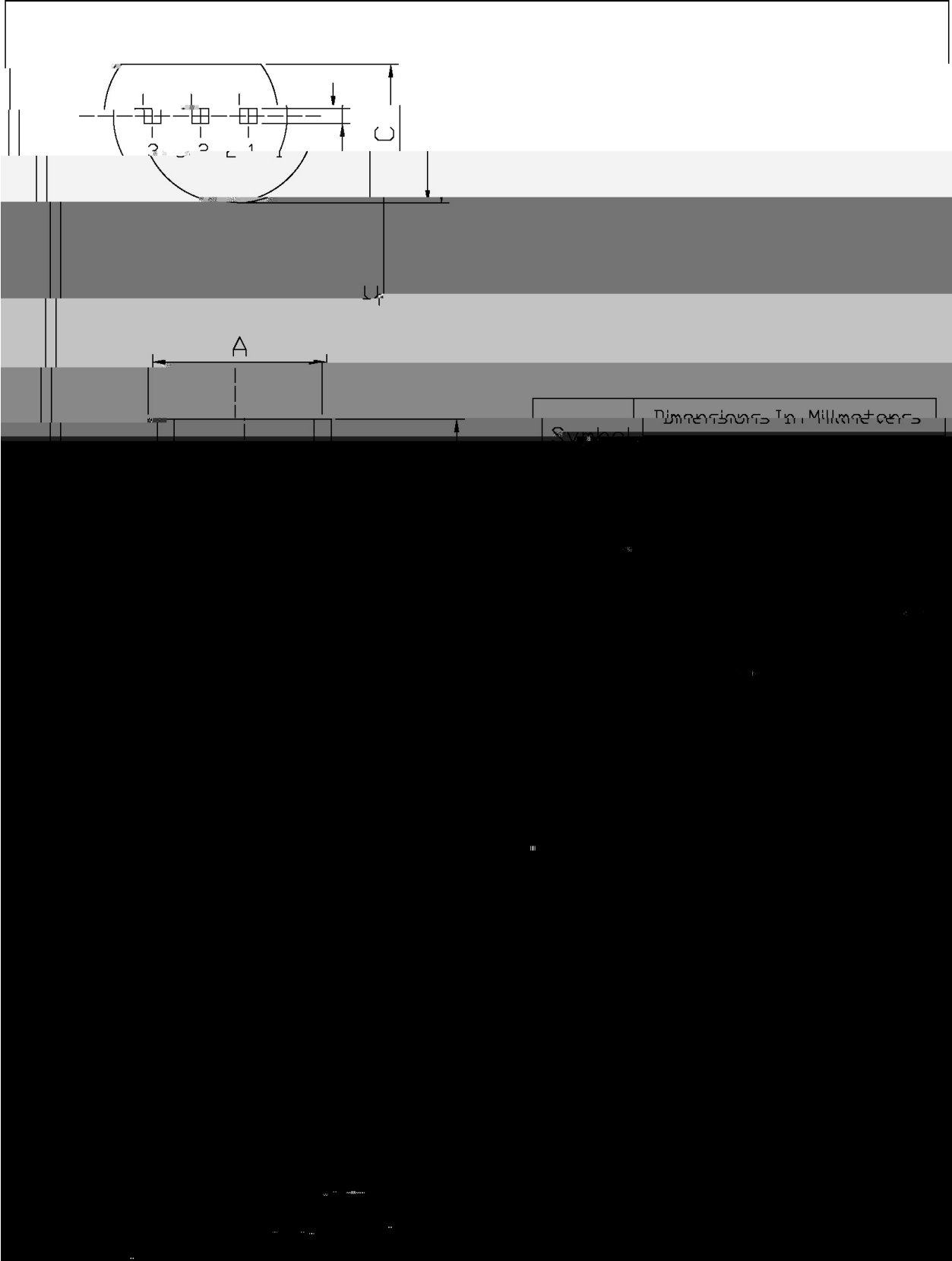
$f_T - I_C$



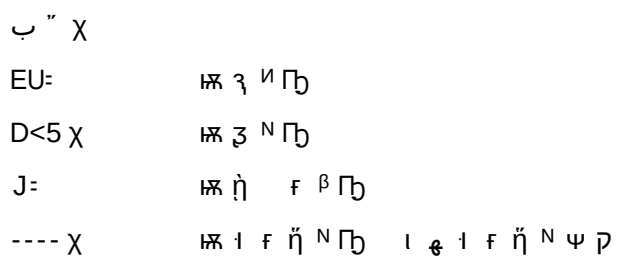
/ Package Dimensions

TO-92

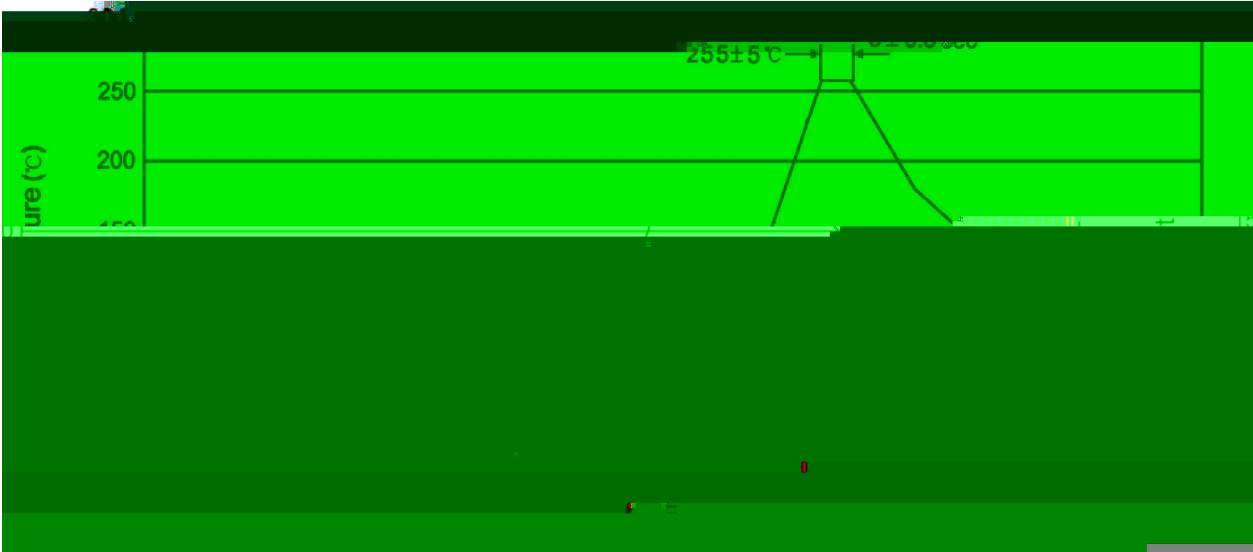
Unit: mm



/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



1. The temperature profile for dip soldering is as follows:
The temperature of the soldering iron is 255±5°C.
The temperature of the component is 150°C.
The temperature of the solder is 150°C.
The temperature of the component is 150°C.

/ Resistance to Soldering Heat Test Conditions

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/ Packaging SPEC.

“Q T Y E

	Units/Bag /	Bags/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Bag	Inner Box	Outer Box
TO-92	1,000	10	10,000	5	50,000	135×190	237×172×102	560×245×195
	1,000	10	Bag6	re10	T8(600023	T8(600023	13384237×172×79(102)75(	173560×245